onsemi

MOSFET - Power, Single N-Channel, STD Gate, SO8-FL

40 V, 0.52 mΩ, 414 A

NVMFWS0D5N04XM

Features

- Low RDS(on) to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Small Footprint (5 x 6 mm) with Compact Design
- AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

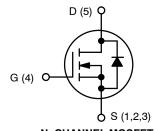
- Motor Drive
- Battery Protection
- Synchronous Rectification

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Parameter		Symbol	Value	Unit
Drain-to-Source Voltage		V _{DSS}	40	V
Gate-to-Source Voltage	V _{GS}	±20	V	
Continuous Drain Current	us Drain Current $T_{\rm C} = 25^{\circ}{\rm C}$		414	А
	$T_{C} = 100^{\circ}C$		293	
Power Dissipation	$T_C = 25^{\circ}C$	PD	163	W
Pulsed Drain Current	$T_{\rm C} = 25^{\circ}{\rm C},$	I _{DM}	900	А
Pulsed Source Current (Body Diode)	t _p = 10 μs	I _{SM}	900	
Operating Junction and Storag Range	T _J , T _{STG}	–55 to +175	°C	
Source Current (Body Diode)	I _S	251	А	
Single Pulse Avalanche Energy	I _{PK} = 28.2 A	E _{AS}	1434	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
40 V	$0.52 \text{ m}\Omega @ 10 \text{ V}$	414 A

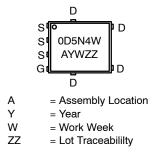


N-CHANNEL MOSFET



DFNW5 (SO-8FL WF) CASE 507BD

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

THERMAL CHARACTERISTICS

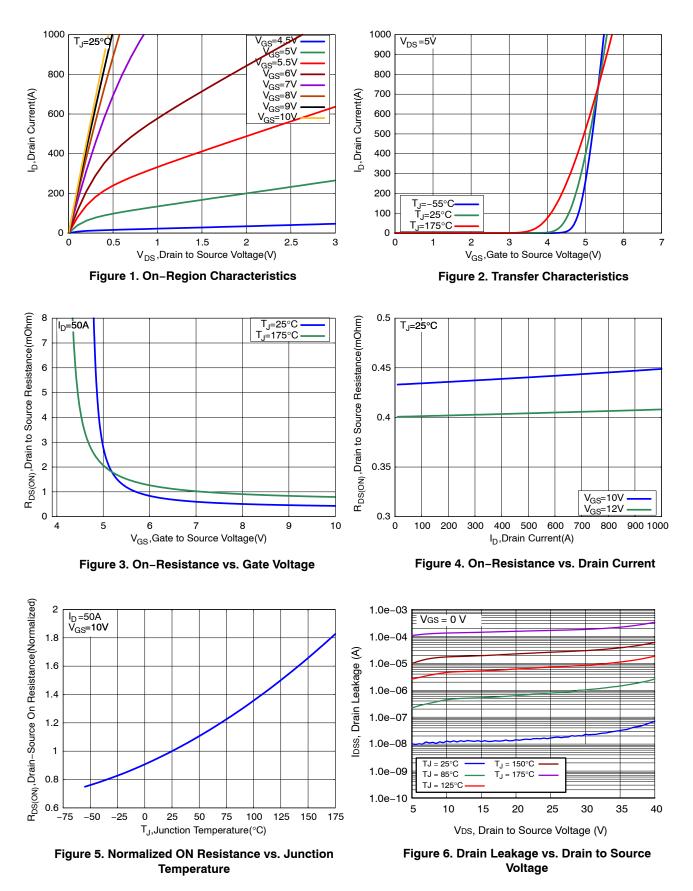
Parameter		Value	Unit
Thermal Resistance, Junction-to-Case (Note 2)		0.92	°C/W
Thermal Resistance, Junction-to-Ambient (Notes 1, 2)	R_{\thetaJA}	38.9	

 Surface-mounted on FR4 board using 650 mm² pad, 2 oz Cu pad.
The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

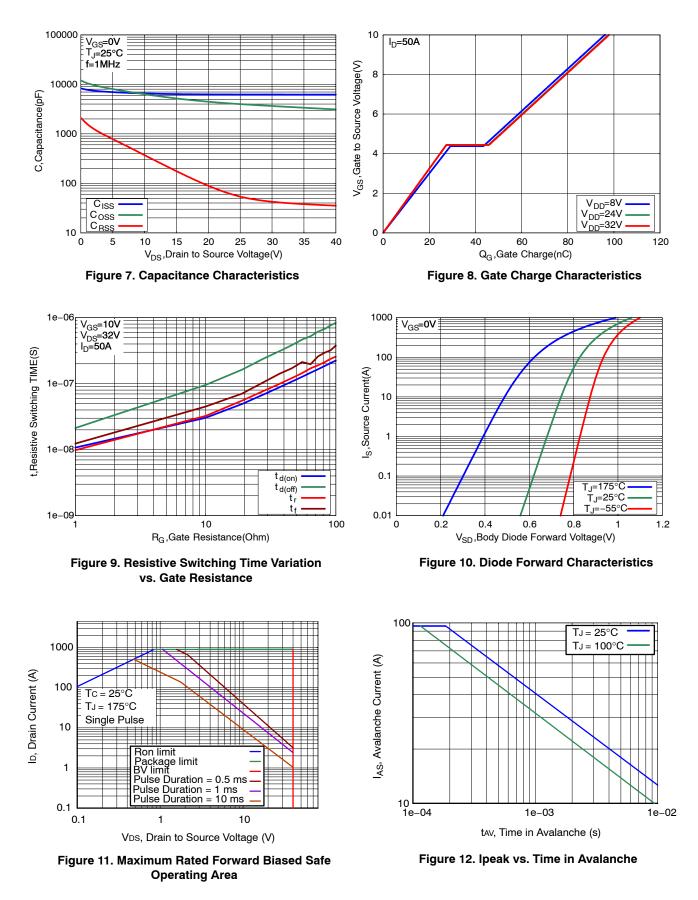
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 1 mA, T _J = 25°C	40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$\Delta V_{(BR)DSS}$	$I_D = 1 \text{ mA}$, Referenced to 25°C		15		mV/°0
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 40 V, T_J = 25°C			1	μΑ
		V _{DS} = 40 V, T _J = 125°C			60	
Gate-to-Source Leakage Current	I _{GSS}	V_{GS} = 20 V, V_{DS} = 0 V			100	nA
ON CHARACTERISTICS		•				
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 10 V, I _D = 50 A, T _J = 25°C		0.43	0.52	mΩ
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 240 μ A, T_J = 25°C	2.5	3.0	3.5	V
Gate Threshold Voltage Temperature Coefficient	$\Delta V_{GS(TH)} / \Delta T_J$	V_{GS} = V_{DS} , I_D = 240 μ A		-7.21		mV/°0
Forward Trans-conductance	9 FS	V _{DS} = 5 V, I _D = 50 A		267		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE		-	-	-	-
Input Capacitance	C _{ISS}	V_{DS} = 25 V, V_{GS} = 0 V, f = 1 MHz		6232		pF
Output Capacitance	C _{OSS}	1 1		3987		1
Reverse Transfer Capacitance	C _{RSS}			53.9		
Total Gate Charge	Q _{G(TOT)}	V_{DD} = 32 V, I _D = 50 A, V _{GS} = 6 V		60.5		nC
Total Gate Charge	Q _{G(TOT)}	V_{DD} = 32 V, I _D = 50 A, V _{GS} = 10 V		97.9		1
Threshold Gate Charge	Q _{G(TH)}			18.2		
Gate-to-Source Charge	Q _{GS}			27.4		
Gate-to-Drain Charge	Q _{GD}			18.5		1
Gate Resistance	R _G	f = 1 MHz		0.47		Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(ON)}	Resistive Load, V _{GS} = 0/10 V,		8.64		ns
Rise Time	tr	V_{DD} = 32 V, I _D = 50 A, R _G = 0 Ω		7.02		1
Turn–Off Delay Time	t _{d(OFF)}			13.7		1
Fall Time	t _f			6.85		1
SOURCE-TO-DRAIN DIODE CHARACTE	RISTICS					
Forward Diode Voltage	V _{SD}	$I_{\rm S}$ = 50 A, $V_{\rm GS}$ = 0 V, $T_{\rm J}$ = 25°C		0.8	1.2	V
		I_{S} = 50 A, V_{GS} = 0 V, T_{J} = 125°C		0.65		
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 V, I_{S} = 50 A,$		101		ns
Charge Time	ta	dl/dt = 100 A/μs, V _{DD} = 32 V		56.9		1
Discharge Time	t _b			44.8		1
Reverse Recovery Charge	Q _{RR}	1		286		nC

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

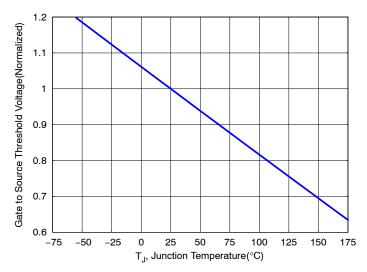
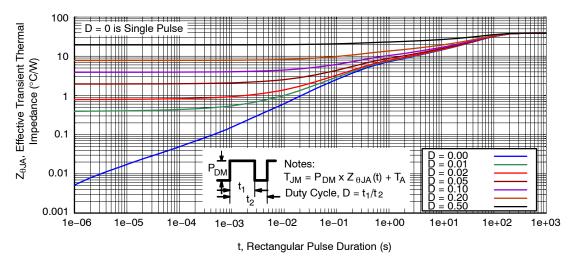


Figure 13. Gate Threshold Voltage vs. Junction Temperature





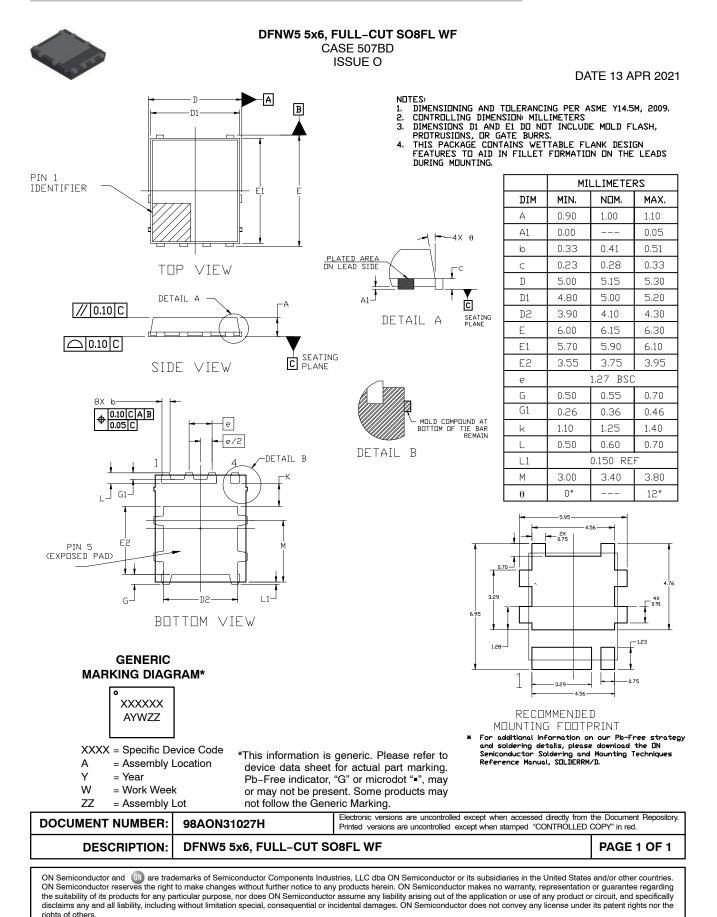
DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFWS0D5N04XMT1G	0D5N4W	DFNW5 (Pb–Free)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





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